

Applicant : **Peterson et al.**
Application No. : **10/082,961**
Filed : **02/25/2002**
Title : **BI-LEVEL MICROELECTRONIC DEVICE PACKAGE WITH
AN INTEGRAL WINDOW**
Art Unit : **2827**
Examiner : **Luan Thai**
Docket No. : **SD-7122**

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DEC 05 2002

Honorable Commissioner for Patents
Washington DC 20231

TECHNOLOGY CENTER 2800

REPLY TO SECOND RESTRICTION REQUIREMENT

Sir:

In response to the Second Restriction Requirement of 11/05/2002, applicants elect the single disclosed species of **Embodiment II**, directed to a package comprising a window being an encased joint geometry related to the body (e.g., Figure 16), a second microelectronic device wire-bonded to the second conductor on the second interior ledge and recitation "a", which covers claims **1, 3, 9, 12-16, 18-20, 21-38, and 40-41**, for prosecution on the merits to which the claims shall be restricted if no generic claim is finally held to be allowable. Currently, claims **1** and **21** are generic claims.

Respectfully submitted,

Robert D. Watson

Robert D. Watson
Agent for Applicants
Reg. No. 45,604
Ph: (505) 845-3139
Fax: (505) 844-1418
e-mail: rdwatso@sandia.gov
Sandia National Laboratories
P.O. Box 5800 MS-0161
Albuquerque, NM 87185-0161

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I hereby certify that this correspondence is being facsimile transmitted to the United States Patent and Trademark Office, Fax No (703) 872-9318, on the date shown below.

Date: 12/05/02

By: Robert D. Watson
Robert D. Watson